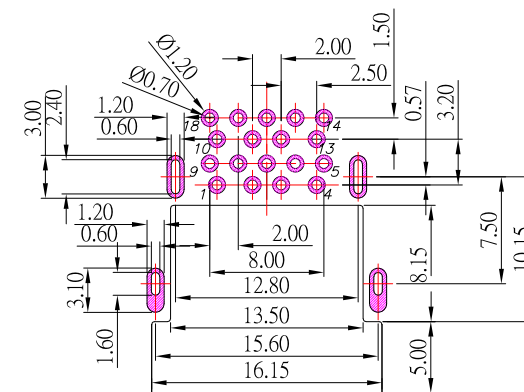
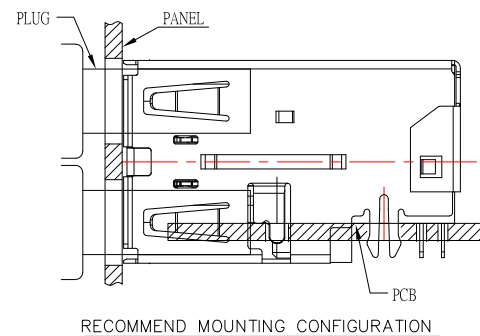
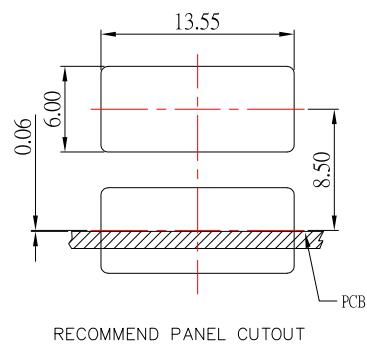
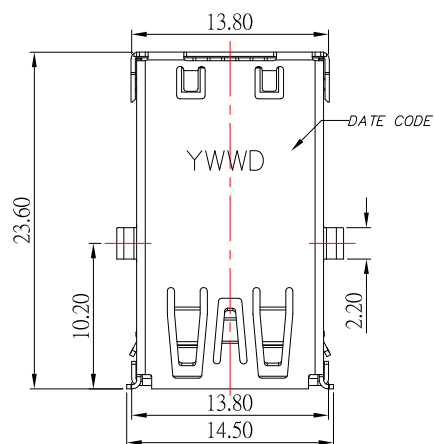
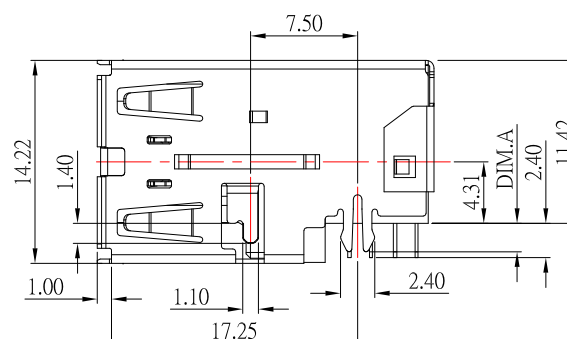
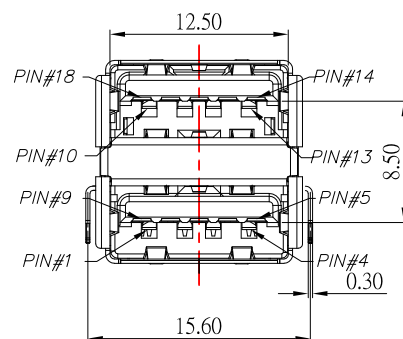




PCB LAYOUT
TOP VIEW

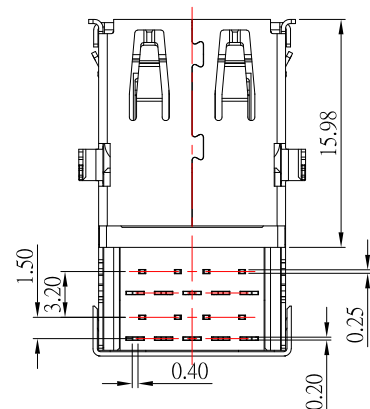


SUA-210EHS2x30x-S410

Blank	2.0mm
A	2.4mm

— 鍍層厚度：

Blank : 1u"
2 : 15u"
3 : 30u"



NOTE:

1.MATERIAL:

- 1.1 Housing: PA4T,Blue
1.2 Cover: PA4T,Blue
1.3 Contact: 4PIN-Phosphor Bronze
5PIN-Brass

3.SPECIFICATION:

- 3.1 Rating: 1.0A
3.2 Insulator Resistance: 100M Ω Min
3.3 Dielectric Strength: 100V AC
3.4 Contact Resistance: 30m Ω Max

2.Finish:

- 2.1 Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.2 Shell: Nickel under Plated surface layer



東莞市高迪電子有限公司
DONG GUAN GAO DI ELECTRONICS CO., LTD

TOLERANCE UNLESS OTHERWISE STATED :	Up to 5	± 0.2	3RD. ANGEL'S		UNITS	MM
	Above 5 ~ 15	± 0.3				
	Above 15 ~ 30	± 0.4				
	Above 30 ~ 50	± 0.5				
	Angle	$\pm 0.3^\circ$				

DRAWN BY:	DATE	MAT'L		TITLE	CONNECTOR	
Jack Lu	08/27/25					
CHECKED BY:	DATE	FINISH		MODLE	USB AF 3.0 雙層沉板 DIP 90 度 L23.60	
Jacky Chen	08/27/25					
APPROVED BY:	DATE	SCALE	1 : 1	DWG NO.	SUA-210EHS2x30x-S410	SIZE
						A4
Tony Kao	08/27/25	SHEET NO.	1 of 1	PART NO.	SUA-210EHS2x30x-S410	VER
						R